TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (π-MOSII<sup>.5</sup>)

# 2SK1120

#### DC-DC Converter and Motor Drive Applications

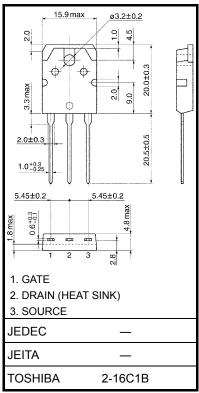
Unit: mm

• Low drain–source ON resistance : RDS (ON) = 1.5  $\Omega$  (typ.) • High forward transfer admittance :  $|Y_{fs}| = 4.0 \text{ S (typ.)}$ • Low leakage current :  $I_{DSS} = 300 \mu A (max) (V_{DS} = 800 \text{ V})$ 

• Enhancement mode :  $V_{th} = 1.5 \text{ to } 3.5 \text{ V (V}_{DS} = 10 \text{ V, I}_{D} = 1 \text{ mA)}$ 

## **Absolute Maximum Ratings (Ta = 25°C)**

Characteristics		Symbol	mbol Rating		
Drain-source voltage		$V_{DSS}$	1000	V	
Drain-gate voltage (R <sub>GS</sub> = 20 kΩ)		$V_{DGR}$	1000	V	
Gate-source voltage		$V_{GSS}$	±20	V	
Drain current	DC (Note 1)	ΙD	8	Α	
	Pulse (Note 1)	I <sub>DP</sub>	24	"	
Drain power dissipation (Tc = 25°C)		$P_{D}$	150	W	
Channel temperature		T <sub>ch</sub>	150	°C	
Storage temperature range		T <sub>stg</sub>	−55 to 150	°C	



Weight: 4.6 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

#### **Thermal Characteristics**

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	R <sub>th (ch-c)</sub>	0.833	°C/W
Thermal resistance, channel to ambient	R <sub>th (ch-a)</sub>	50	°C/W

Note 1: Ensure that the channel temperature does not exceed 150°C.

This transistor is an electrostatic-sensitive device.

Please handle with caution.

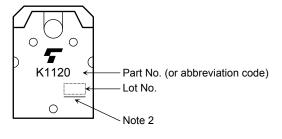
## **Electrical Characteristics (Ta = 25°C)**

Charac	cteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cu	ırrent	I <sub>GSS</sub>	V <sub>GS</sub> = ±20 V, V <sub>DS</sub> = 0 V	_	_	±100	nA
Drain cut-off cu	rrent	I <sub>DSS</sub>	V <sub>DS</sub> = 800 V, V <sub>GS</sub> = 0 V	_	_	300	μA
Drain-source br	eakdown voltage	V (BR) DSS	I <sub>D</sub> = 10 mA, V <sub>GS</sub> = 0 V	1000	_	_	V
Gate threshold v	/oltage	V <sub>th</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 mA	1.5	_	3.5	V
Drain-source O	N resistance	R <sub>DS</sub> (ON)	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 4 A	_	1.5	1.8	Ω
Forward transfer	r admittance	Y <sub>fs</sub>	V <sub>DS</sub> = 20 V, I <sub>D</sub> = 4 A	2.0	4.0	_	S
Input capacitano	e	C <sub>iss</sub>		_	1300	_	
Reverse transfe	verse transfer capacitance $C_{rss}$ $V_{DS}$ = 25 V, $V_{GS}$ = 0 V, f = 1 MHz		_	100	_	pF	
Output capacitance		Coss		_	180	_	
Switching time Fall ti	Rise time	t <sub>r</sub>	V <sub>GS</sub> <sub>0V</sub> V <sub>OUT</sub> R <sub>L</sub> = 100Ω	_	25	_	- ns
	Turn-on time	t <sub>on</sub>		_	40	_	
	Fall time	t <sub>f</sub>		_	20	_	
	Turn-off time	t <sub>off</sub>	$V_{DD} = 400V$ Duty $\leq 1\%$ , $t_w = 10 \mu s$	_	100	_	
Total gate charge (Gate-source plus gate-drain)		Qg			120	-	
Gate-source charge		Q <sub>gs</sub>	$V_{DD} \approx 400 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 8 \text{ A}$	_	70	_	nC
Gate-drain ("miller") charge		$Q_{gd}$			50	_	

## Source-Drain Ratings and Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I <sub>DR</sub>	_	_	1	8	Α
Pulse drain reverse current (Note 1)	I <sub>DRP</sub>	_	_	-	24	Α
Forward voltage (diode)	$V_{DSF}$	I <sub>DR</sub> = 8 A, V <sub>GS</sub> = 0 V	_	_	-1.9	V

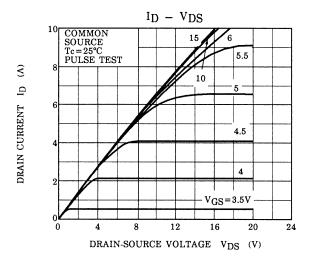
#### Marking

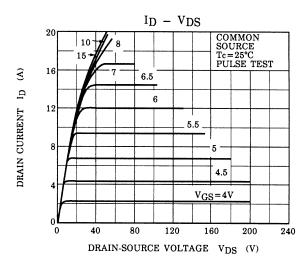


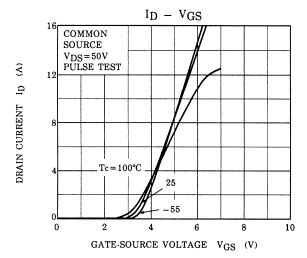
Note 2: A line under a Lot No. identifies the indication of product Labels.

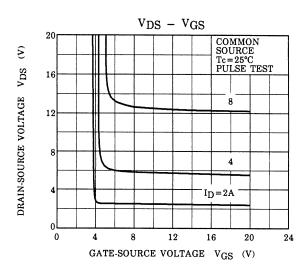
Not underlined: [[Pb]]/INCLUDES > MCV Underlined: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

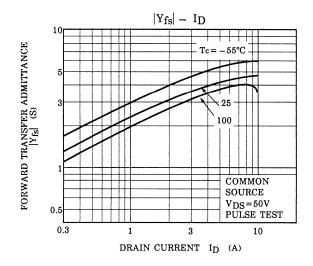
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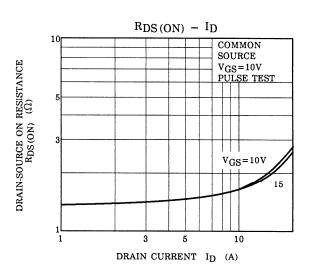




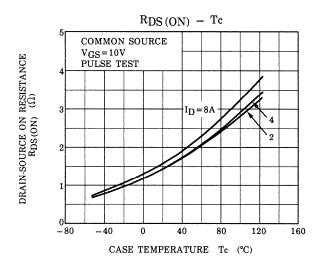


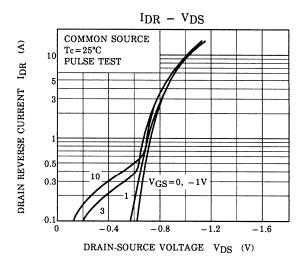


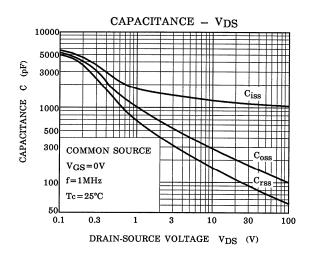


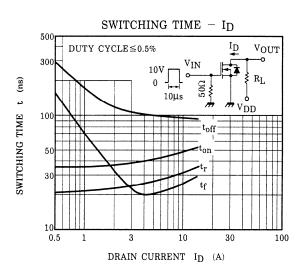


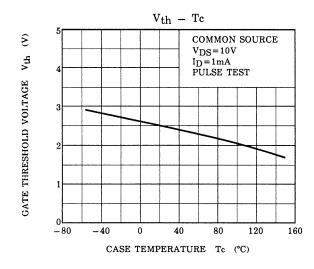
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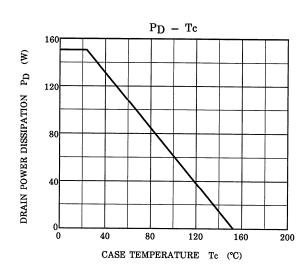


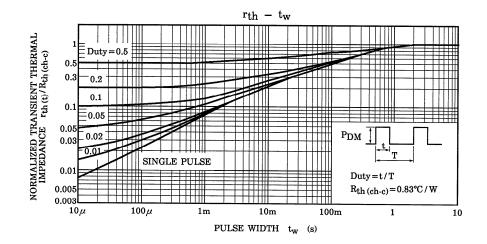


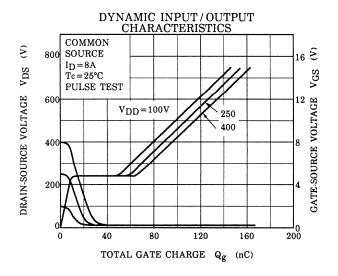


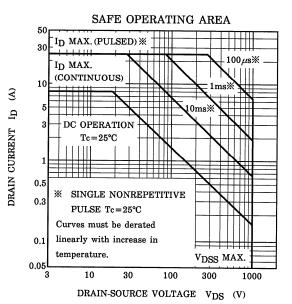












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